## General Description

The MAX3060E/MAX3061E/MAX3062E high-speed transceivers for RS-485/RS-422 communication contain one driver and one receiver. These devices feature failsafe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted. This means that the receiver output is a logic high if all transmitters on a terminated bus are disabled (high impedance). These devices also feature hot-swap circuitry that eliminates data glitches during hot insertion.
The MAX3060E features slew-rate-limited drivers that minimize EMI and reduce reflections caused by improperly terminated cables, allowing error-free data transmission up to 115 kbps . The MAX3061E, also slew-rate limited, transmits up to 500kbps. The MAX3062E driver is not slew-rate limited, allowing transmit speeds up to 20 Mbps . All transmitter outputs are protected to $\pm 15 \mathrm{kV}$ using the Human Body Model.
These transceivers typically draw $910 \mu \mathrm{~A}$ of supply current when unloaded, or $790 \mu \mathrm{~A}$ when fully loaded with the drivers disabled.
All devices have a 1/8-unit-load receiver input impedance that allows up to 256 transceivers on the bus. These devices are intended for half-duplex communication.

## Applications

- RS-422/RS-485 Communications
- Level Translators
- Transceivers for EMI-Sensitive Applications
- Industrial-Control Local-Area Networks


## Features

- True Fail-Safe Receiver While Maintaining EIA/TIA-485 Compatibility
- Enhanced Slew-Rate Limiting Facilitates
- Error-Free Data Transmission (MAX3060E and MAX3061E)
- 1nA Low-Current Shutdown Mode
- Hot-Swappable for Telecom Applications
- ESD Protection: $\pm 15 \mathrm{kV}$ Human Body Model
- Allow Up to 256 Transceivers on the Bus
- Space-Saving 8-Pin SOT23 Package


## Ordering Information

| PART | TEMP RANGE | PIN- <br> PACKAGE |
| :---: | :--- | :--- |
| MAX3060EEKA+T | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 SOT23-8 |
| MAX3061EEKA+T | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 SOT23-8 |
| MAX3062EEKA+T | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8 SOT23-8 |

+Denotes a lead-free package.
$T$ = Tape and Reel

## Selector Guide

| PART | DATA <br> RATE <br> (MBPS) | SLEW- <br> RATE <br> LIMITED | TRANSCEIVERS <br> ON BUS |
| :---: | :---: | :---: | :---: |
| MAX3060E | 0.115 | Yes | 256 |
| MAX3061E | 0.5 | Yes | 256 |
| MAX3062E | 20 | No | 256 |

## Typical Operating Circuit/Pin Configuration



## Absolute Maximum Ratings

All Voltages with Respect to GND
Supply Voltage (VCC)$+7 \mathrm{~V}$

Driver Output/Receiver Input Voltage (A, B) ............ V to +12.5 V
Receiver Output Voltage (RO) .................. 0.3 V to ( $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ )
Continuous Power Dissipation ( $\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}$ )
8-Pin SOT23 (derate $8.9 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) .......... 714 mW
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC Electrical Characteristics

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. $)($ Notes 1,2$)$

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DRIVER |  |  |  |  |  |  |  |
| Differential Driver Output (No Load) | $\mathrm{V}_{\text {OD1 }}$ | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ |  |  |  | 5 | V |
| Differential Driver Output | $\mathrm{V}_{\text {OD2 }}$ | Figure 1, $\mathrm{R}=50 \Omega$ (RS-422) |  | 2.0 |  |  | V |
|  |  | Figure 1, $\mathrm{R}=27 \Omega$ (RS-485) |  | 1.5 |  |  |  |
| Change in Magnitude of Differential Output Voltage | $\Delta \mathrm{V}_{\mathrm{OD}}$ | Figure 1, $\mathrm{R}=50 \Omega$ or $\mathrm{R}=27 \Omega$ ( Note 3) |  |  |  | 0.2 | V |
| Driver Common-Mode Output Voltage | $\mathrm{V}_{\mathrm{OC}}$ | Figure 1, R = 50 or $\mathrm{R}=27 \Omega$ |  |  |  | 3 | V |
| Change in Magnitude of Common-Mode Voltage | $\Delta \mathrm{V}_{\text {OC }}$ | Figure 1, $\mathrm{R}=50 \Omega$ or $\mathrm{R}=27 \Omega$ ( Note 3) |  |  |  | 0.2 | V |
| Input High Voltage | $\mathrm{V}_{\text {IH }}$ | DE, DI, $\overline{\mathrm{RE}}$ |  | 2.0 |  |  | V |
| Input Low Voltage | $\mathrm{V}_{\text {IL }}$ | DE, DI, $\overline{\mathrm{RE}}$ |  |  |  | 0.8 | V |
| DI Input Hysteresis | $\mathrm{V}_{\mathrm{HYS}}$ |  |  |  | 100 |  | mV |
| Input Current | In1 | DE, DI, $\overline{\mathrm{RE}}$ |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| Hot-Swap Driver Input Current | Inotswap | DE, $\overline{\mathrm{RE}}$ (Note 4) |  |  |  | $\pm 200$ | $\mu \mathrm{A}$ |
| Input Current (A and B) | $\mathrm{I}_{1}$ 2 | $\begin{aligned} & \mathrm{DE}=\mathrm{GND}, \\ & \mathrm{~V}_{\mathrm{CC}}=\mathrm{GND} \text { or } 5.25 \mathrm{~V} \end{aligned}$ | $\mathrm{V}_{\text {IN }}=+12 \mathrm{~V}$ |  |  | 125 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\text {IN }}=-7 \mathrm{~V}$ | -100 |  |  |  |
| Driver Short-Circuit Output Current | $\mathrm{V}_{\text {OD1 }}$ | $-7 \mathrm{~V} \leq \mathrm{V}_{\text {OUT }} \leq+12 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ (Note 5) |  | $\pm 15$ |  | $\pm 250$ | mA |
| ESD Protection for A, B |  | IEC 1000-4-2 Air-Gap Discharge |  |  | $\pm 7$ |  | kV |
|  |  | IEC 1000-4-2 Contact Discharge |  |  | $\pm 7$ |  |  |
|  |  | Human Body Model |  |  | $\pm 15$ |  |  |

## Electrical Characteristics (continued)

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.) (Notes 1, 2)

| PARAMETER | SYMBOL | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RECEIVER |  |  |  |  |  |  |  |
| Receiver Differential Threshold Voltage | $\mathrm{V}_{\mathrm{TH}}$ | $-7 \mathrm{~V} \leq \mathrm{VCM} \leq+12 \mathrm{~V}$ |  | -200 | -125 | -50 | mV |
| Receiver Input Hysteresis | $\Delta \mathrm{V}_{\text {TH }}$ |  |  |  | 25 |  | mV |
| Receiver Output High Voltage | $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{I}_{\mathrm{O}}=-4 \mathrm{~mA}, \mathrm{~V}_{\text {ID }}=-50 \mathrm{mV}$ |  | $\mathrm{V}_{C C}-1.5$ |  |  | V |
| Receiver Output Low Voltage | $\mathrm{V}_{\mathrm{OL}}$ | $\mathrm{I}_{\mathrm{O}}=4 \mathrm{~mA}, \mathrm{~V}_{\text {ID }}=-200 \mathrm{mV}$ |  |  |  | 0.4 | V |
| Three-State Output Current at Receiver | IozR | $\mathrm{OV} \leq \mathrm{V}_{\mathrm{O}} \leq \mathrm{V}_{\mathrm{CC}}$ |  |  | 0.01 | $\pm 1$ | $\mu \mathrm{A}$ |
| Receiver Input Resistance | $\mathrm{R}_{\mathrm{IN}}$ | $-7 \mathrm{~V} \leq \mathrm{V}_{\mathrm{CM}} \leq+12 \mathrm{~V}$ |  | 96 |  |  | k $\Omega$ |
| Receiver Output Short-Circuit Current | IOSR | $\mathrm{O} \leq \mathrm{V}_{\mathrm{RO}} \leq \mathrm{V}_{\mathrm{CC}}$ |  | $\pm 8$ |  | $\pm 80$ | mA |
| SUPPLY CURRENT |  |  |  |  |  |  |  |
| Supply Current | ICC | No load,$\mathrm{DI}=\mathrm{GND} \text { or } \mathrm{V}_{\mathrm{CC}}$ | DE $=\overline{\mathrm{RE}}=\mathrm{GND}$ |  | 790 | 1400 | $\mu \mathrm{A}$ |
|  |  |  | $\overline{\mathrm{DE}}=\overline{\mathrm{RE}}=\mathrm{V}_{\mathrm{CC}}$ |  | 910 | 1500 |  |
| Supply Current in Shutdown Mode | ISHDN | $D E=G N D, \overline{R E}=V_{C C}$ |  |  | 0.001 | 1 | $\mu \mathrm{A}$ |

## Switching Characteristics—MAX3060E

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. $)($ Notes 1,2$)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Driver Input to Output | tDPLH, <br> tDPHL | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | 1.0 | 1.7 | 2.4 | $\mu \mathrm{s}$ |
| Driver Output Skew ( $\mathrm{t}_{\mathrm{DPLH}}$ - $\mathrm{t}_{\mathrm{DPHL}}$ ) | t ${ }_{\text {DSKEW }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | -200 | -7 | +200 | ns |
| Driver Rise or Fall Time | $t_{\text {DR }}, t_{\text {DF }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | 1.3 | 1.85 | 2.5 | $\mu \mathrm{s}$ |
| Maximum Data Rate | $\mathrm{f}_{\text {MAX }}$ |  | 115 |  |  | kbps |
| Driver Enable to Output High | $t_{\text {DZH }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}$, S2 closed |  | 0.6 | 1.5 | $\mu \mathrm{s}$ |
| Driver Enable to Output Low | $t_{\text {t }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}$, S1 closed |  | 0.5 | 1.5 | $\mu \mathrm{s}$ |
| Driver Disable Time from Low | $\mathrm{t}_{\text {DLZ }}$ | Figures 4 and 6, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  | 60 | 200 | ns |
| Driver Disable Time from High | $t_{\text {DHZ }}$ | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, S2 closed |  | 85 | 200 | ns |
| Receiver Input to Output | $t_{\text {RPLH }}$, trPHL | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\mathrm{ID}} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 47 | 80 | ns |
| Differential Receiver Skew ( $\mathrm{t}_{\mathrm{RPLH}}-\mathrm{t}_{\mathrm{RPHL}}$ ) | $t_{\text {tRSKD }}$ | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\mathrm{ID}} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | -10 | -3 | +10 | ns |
| Receiver Enable to Output Low | $t_{\text {RZL }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Enable to Output High | $t_{\text {RZH }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 2$ closed |  |  | 50 | ns |
| Receiver Disable Time from Low | $\mathrm{t}_{\text {RLZ }}$ | Figures 2 and $8, C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Disable Time from High | $\mathrm{t}_{\mathrm{RHZ}}$ | Figures 2 and $8, C_{L}=15 \mathrm{pF}, \mathrm{S} 2$ closed |  |  | 50 | ns |
| Time to Shutdown | $\mathrm{t}_{\text {SHDN }}$ | (Note 6) | 50 | 180 | 600 | ns |
| Driver Enable from Shutdown to Output High | $t_{\text {DZH }}$ (SHDN) | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, S 2 closed |  |  | 2 | $\mu \mathrm{s}$ |
| Driver Enable from Shutdown to Output Low | $t_{\text {DZL }}$ (SHDN) | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 2 | $\mu \mathrm{s}$ |
| Receiver Enable from Shutdown to Output High | $t_{\text {RZH }}$ (SHDN) | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 2$ closed |  |  | 1.5 | $\mu \mathrm{s}$ |
| Receiver Enable from Shutdown to Output Low | ${ }^{\text {tRZL }}$ (SHDN) | Figures 2 and 8, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 1.5 | $\mu \mathrm{s}$ |

## Switching Characteristics—MAX3061E

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. $)($ Notes 1,2$)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Driver Input to Output | $t_{\text {DPLH, }}$ tDPHL | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | 250 | 470 | 800 | ns |
| Driver Output Skew ( $\mathrm{t}_{\mathrm{DPLH}}$ - $\mathrm{t}_{\mathrm{DPHL}}$ ) | $t_{\text {DSKEW }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | -100 | -4 | +100 | ns |
| Driver Rise or Fall Time | $t_{\text {DR }}, t_{\text {DF }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | 200 | 530 | 750 | ns |
| Maximum Data Rate | $\mathrm{f}_{\text {MAX }}$ |  | 500 |  |  | kbps |
| Driver Enable to Output High | $t_{\text {DZH }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}$, 22 closed |  | 330 | 1000 | ns |
| Driver Enable to Output Low | $t_{\text {DZL }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}, \mathrm{S} 1$ closed |  | 200 | 1000 | ns |
| Driver Disable Time from Low | ${ }_{\text {t }}^{\text {DLZ }}$ | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, S1 closed |  | 60 | 200 | ns |
| Driver Disable Time from High | $t_{\text {DHZ }}$ | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, S2 closed |  | 80 | 200 | ns |
| Receiver Input to Output | $t_{\text {RPLH }}$, $t_{\text {RPHL }}$ | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\text {ID }} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 47 | 80 | ns |
| Differential Receiver Skew ( $\mathrm{t}_{\mathrm{RPLH}}-\mathrm{t}_{\mathrm{RPHL}}$ ) | $t_{\text {tRSK }}$ | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\mathrm{ID}} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | -10 | -3 | +10 | ns |
| Receiver Enable to Output Low | $t_{\text {RZL }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Enable to Output High | $t_{\text {RZH }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}$, S2 closed |  |  | 50 | ns |
| Receiver Disable Time from Low | $\mathrm{t}_{\text {RLZ }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Disable Time from High | $t_{\text {RHZ }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}$, S2 closed |  |  | 50 | ns |
| Time to Shutdown | $\mathrm{t}_{\text {SHDN }}$ | (Note 6) | 50 | 180 | 600 | ns |
| Driver Enable from Shutdown to Output High | ${ }^{\text {t }}$ LZH(SHDN) | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, S 2 closed |  |  | 1.5 | $\mu \mathrm{s}$ |
| Driver Enable from Shutdown to Output Low | $t_{\text {DZL }}$ (SHDN) | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, S1 closed |  |  | 1.5 | $\mu \mathrm{s}$ |
| Receiver Enable from Shutdown to Output High | ${ }^{\text {tRZH(SHDN }}$ ) | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 2$ closed |  |  | 1.5 | $\mu \mathrm{s}$ |
| Receiver Enable from Shutdown to Output Low | $t_{\text {RZL }}$ (SHDN) | Figures 2 and 8, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 1.5 | $\mu \mathrm{s}$ |

## Switching Characteristics—MAX3062E

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V} \pm 5 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. $)($ Notes 1,2$)$

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Driver Input to Output | tDPLH, $t_{\text {DPHL }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ |  | 20 | 30 | ns |
| Driver Output Skew ( $\mathrm{t}_{\mathrm{DPLH}}$ - $\mathrm{t}_{\mathrm{DPHL}}$ ) | $t_{\text {DSKEW }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ | -10 | +1 | +10 | ns |
| Driver Rise or Fall Time | ${ }^{\text {t }}$, $t_{\text {dF }}$ | Figures 3 and $5, R_{\text {DIFF }}=54 \Omega$, $C_{\text {DIFF }}=50 \mathrm{pF}$ |  | 8 | 15 | ns |
| Maximum Data Rate | $\mathrm{f}_{\text {MAX }}$ |  | 20 |  |  | Mbps |
| Driver Enable to Output High | $t_{\text {DZH }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}$, 22 closed |  | 250 | 500 | ns |
| Driver Enable to Output Low | $t_{\text {DZL }}$ | Figures 4 and 6, $C_{L}=100 \mathrm{pF}, \mathrm{S} 1$ closed |  | 250 | 500 | ns |
| Driver Disable Time from Low | ${ }_{\text {t }}$ DLZ | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, S1 closed |  | 100 | 200 | ns |
| Driver Disable Time from High | $t_{\text {DHZ }}$ | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$, S2 closed |  | 100 | 200 | ns |
| Receiver Input to Output | $t_{\text {RPLH }}$, $t_{\text {RPHL }}$ | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\mathrm{ID}} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ |  | 45 | 80 | ns |
| Differential Receiver Skew ( $\mathrm{t}_{\mathrm{RPLH}}-\mathrm{t}_{\mathrm{RPHL}}$ ) | $t_{\text {RSKD }}$ | Figures 7 and $9 ;\left\|\mathrm{V}_{\mathrm{ID}}\right\| \geq 2.0 \mathrm{~V}$; rise and fall time of $\mathrm{V}_{\text {ID }} \leq 4 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$ | -10 | -4 | +10 | ns |
| Receiver Enable to Output Low | $\mathrm{t}_{\text {RZL }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Enable to Output High | $\mathrm{t}_{\text {RZH }}$ | Figures 2 and $8, C_{L}=15 \mathrm{pF}$, S2 closed |  |  | 50 | ns |
| Receiver Disable Time from Low | $\mathrm{t}_{\mathrm{RLZ}}$ | Figures 2 and $8, C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 50 | ns |
| Receiver Disable Time from High | $t_{\text {RHZ }}$ | Figures 2 and 8, $C_{L}=15 \mathrm{pF}$, S2 closed |  |  | 50 | ns |
| Time to Shutdown | ${ }^{\text {t SHDN }}$ | (Note 6) | 50 | 180 | 600 | ns |
| Driver Enable from Shutdown to Output High | ${ }^{\text {t }}$ DZH(SHDN) | Figures 4 and 6, $\mathrm{C}_{\mathrm{L}}=100 \mathrm{pF}$, S 2 closed |  |  | 100 | ns |
| Driver Enable from Shutdown to Output Low | $t_{\text {DZL }}$ (SHDN) | Figures 4 and 6, $C_{L}=100 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 100 | ns |
| Receiver Enable from Shutdown to Output High | ${ }^{\text {tRZH(SHDN }}$ ) | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 2$ closed |  |  | 1.5 | $\mu \mathrm{s}$ |
| Receiver Enable from Shutdown to Output Low | $t_{\text {RZL }}$ (SHDN) | Figures 2 and 8, $C_{L}=15 \mathrm{pF}, \mathrm{S} 1$ closed |  |  | 1.5 | $\mu \mathrm{S}$ |

Note 1: Overtemperature limits are guaranteed by design and are not production tested. Devices are tested at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
Note 2: All currents into the device are positive; all currents out of the device are negative. All voltages are referred to device ground, unless otherwise noted.
Note 3: $\Delta \mathrm{V}_{\mathrm{OD}}$ and $\Delta \mathrm{V}_{\mathrm{OC}}$ are the changes in $\mathrm{V}_{\mathrm{OD}}$ and $\mathrm{V}_{\mathrm{OC}}$, respectively, when the DI input changes state.
Note 4: This input current level is for the hot-swap enable ( $D E, \overline{R E}$ ) inputs and is present until the first transition only. After the first transition, the input reverts to a standard high-impedance CMOS input with input current $\mathrm{I}_{\mathrm{IN} 1}$. For the first $10 \mu \mathrm{~s}$, the input current can be as high as 1 mA . During this period the input is disabled.
Note 5: Maximum current level applies to peak current just prior to foldback-current limiting; minimum current level applies during current limiting.
Note 6: The device is put into shutdown by bringing $\overline{R E}$ high and DE low. If the enable inputs are in this state for less than 50 ns , the device is guaranteed not to enter shutdown. If the enable inputs are in this state for at least 600 ns , the device is guaranteed to have entered shutdown.


Figure 1. Driver DC Test Load


Figure 3. Driver Timing Test Circuit


Figure 5. Driver Propagation Delays


Figure 2. Receiver Enable/Disable Timing Test Load


Figure 4. Driver Enable/Disable Timing Test Load


Figure 6. Driver Enable and Disable Times


Figure 7. Receiver Propagation Delays


Figure 8. Receiver Enable and Disable Times


Figure 9. Receiver Propagation Delay Test Circuit

## Typical Operating Characteristics

$\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted.)



RECEIVER OUTPUT CURRENT vs. RECEIVER OUTPUT HIGH VOLTAGE



## Typical Operating Characteristics (continued) <br> $\left(\mathrm{V}_{\mathrm{CC}}=+5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}\right.$, unless otherwise noted.)



Pin Description

| PIN | NAME | FUNCTION |
| :---: | :---: | :--- |
| 1 | RO | Receiver Output. When $\overline{\mathrm{RE}}$ is low and when A - B R -50mV, RO is high; if A - B P -200mV, RO is low. RO <br> is high impedance when $\overline{\mathrm{RE}}$ is high. |
| 2 | $\overline{\mathrm{RE}}$ | Receiver Output Enable. Drive $\overline{\mathrm{RE}}$ low to enable RO; RO is high impedance when $\overline{\mathrm{RE}}$ is high. Drive $\overline{\mathrm{RE}}$ <br> high and DE low to enter low-power shutdown mode. $\overline{\mathrm{RE}}$ is a hot-swap input and reverts to a standard <br> CMOS input after the first low transition. |
| 3 | DE | Driver Output Enable. Drive DE high to enable driver outputs. Driver outputs are high impedance when <br> DE is low. Drive $\overline{R E}$ high and DE low to enter low-power shutdown mode. DE is a hot-swap input and <br> reverts to a standard CMOS input after the first high transition. |
| 4 | DI | Driver Input. With DE high, a low on DI forces the noninverting output low and the inverting output high. <br> Similarly, a high on DI forces the noninverting output high and the inverting output low. |
| 5 | GND | Ground |
| 6 | A | Noninverting Receiver Input and Noninverting Driver Output |
| 7 | B | Inverting Receiver Input and Inverting Driver Output |
| 8 | VCC | Positive Supply. Bypass with a 0.1 $\mu \mathrm{F}$ capacitor to GND. |

## Detailed Description

The MAX3060E/MAX3061E/MAX3062E high-speed transceivers for RS-485/RS-422 communication contain one driver and one receiver. These devices feature failsafe circuitry, which guarantees a logic-high receiver output when the receiver inputs are open or shorted, or when they are connected to a terminated transmission line with all drivers disabled (see the Fail-Safe section). All devices have a hot-swap input structure that prevents disturbances on the differential signal lines when a circuit board is plugged into a hot backplane (see the Hot-Swap Capability section). The MAX3060E features a reduced slew-rate driver that minimizes EMI and reduces reflections caused by improperly terminated cables, allowing error-free data transmission up to 115 kbps (see the Reduced EMI and Reflections section). The MAX3061E is also slew-rate limited, transmitting up to 500 kbps . The MAX3062E driver is not slew-rate limited, allowing transmit speeds up to 20Mbps. The MAX3060E/MAX3061E/ MAX3062E are half-duplex transceivers.
All of these parts operate from a single +5 V supply. Drivers are output short-circuit current limited. Thermal-shutdown circuitry protects drivers against excessive power dissipation. When activated, the thermal-shutdown circuitry places the driver outputs into a high-impedance state.

## Receiver Input Filtering

The receivers of the MAX3060E and MAX3061E incorporate input filtering in addition to input hysteresis. This filtering enhances noise immunity with differential signals that have very slow rise and fall times. Receiver propagation delay increases by 2 ns due to this filtering.

## Fail-Safe

The MAX3060E family of devices guarantee a logic-high receiver output when the receiver inputs are shorted or open, or when they are connected to a terminated transmission line with all drivers disabled. This is done by setting the receiver threshold between -50 mV and -200 mV . If the differential receiver input voltage $(A-B)$ is greater than or equal to $-50 \mathrm{mV}, \mathrm{RO}$ is logic high. If $\mathrm{A}-\mathrm{B}$ is less than or equal to -200 mV , RO is logic low. In the case of a terminated bus with all transmitters disabled, the receiver's differential input voltage is pulled to 0 V by the termination. In the case of an unterminated bus with all transmitters disabled, the receiver's differential input voltage is pulled to 0 V by the receiver's input resistors. With the receiver thresholds of the MAX3060E family, this results in a logic high output with a 50 mV minimum input noise margin. Unlike previous fail-safe devices, the -50 mV to -200 mV threshold complies with the $\pm 200 \mathrm{mV}$ EIA/TIA-485 standard.

Table 2. Receiver Functional Table

| RECEIVING |  |  |  |
| :---: | :---: | :---: | :---: |
| INPUTS |  |  |  |
| $\overline{\mathrm{RE}}$ | DE | $\mathrm{A}-\mathrm{B}$ | ROTPUT |
| 0 | X | $\mathrm{R}-0.05 \mathrm{~V}$ | 1 |
| 0 | X | $\mathrm{P}-0.2 \mathrm{~V}$ | 0 |
| 0 | X | Open/shorted | 1 |
| 1 | 1 | X | High-Z |
| 1 | 0 | X | Shutdown |

while M1 remains on, holding DE low against three-state leakages that can drive DE high. M1 remains on until an external source overcomes the required input current. At this time, the SR latch resets and M1 turns off. When M1 turns off, DE reverts to a standard, high-impedance CMOS input. Whenever $\mathrm{V}_{\mathrm{C}}$ drops below 1 V , the hotswap input is reset.
For $\overline{R E}$, there is a complementary circuit employing two PMOS devices pulling $\overline{\mathrm{RE}}$ to $\mathrm{V}_{\mathrm{CC}}$.


Figure 10. Simplified Structure of the Driver Enable Input (DE)

## Hot-Swap Line Transient

The circuit of Figure 11 shows a typical offset termination used to guarantee a greater than 200 mV offset when a line is not driven (the 50 pF represents the minimum parasitic capacitance that would exist in a typical application). During a hot-swap event when the driver is connected to the line and is powered up, the driver must not cause the differential signal to drop below 200 mV . Figures 12, 13 , and 14 show the results of the MAX3060E during power-up for three different $\mathrm{V}_{\mathrm{CC}}$ ramp rates $(0.1 \mathrm{~V} / \mu \mathrm{s}$, $1 \mathrm{~V} / \mu \mathrm{s}$, and $10 \mathrm{~V} / \mu \mathrm{s}$ ). The photos show the $\mathrm{V}_{\mathrm{C}}$ ramp, the single-ended signal on each side of the $100 \Omega$ termination, as well as the differential signal across the termination.

## $\pm 15 \mathrm{kV}$ ESD Protection

As with all Maxim devices, ESD-protection structures are incorporated on all pins to protect against ESD encountered during handling and assembly. The MAX3060E family's receiver inputs/driver outputs ( $\mathrm{A}, \mathrm{B}$ ) have extra protection against static electricity found in normal operation. Maxim's engineers developed state-of-the-art structures to protect these pins against $\pm 15 \mathrm{kV}$ ESD without damage. After an ESD event, the devices continue working without latchup.
ESD protection can be tested in several ways. The receiver inputs are characterized for protection to the following:

- $\quad \pm 15 \mathrm{kV}$ using the Human Body Model
- $\quad \pm 7 \mathrm{kV}$ using the Contact Discharge method specified in IEC 1000-4-2 (formerly IEC 801-2)
- $\quad \pm 7 \mathrm{kV}$ using the Air-Gap Discharge method specified in IEC 1000-4-2 (formerly IEC 801-2)


Figure 11. Typical Offset Termination


Figure 12. Differential Power-Up Glitch (0.1V/ $\mu \mathrm{s}$ )


Figure 13. Differential Power-Up Glitch (1V/us)


Figure 14. Differential Power-Up Glitch (10V/ $\mu \mathrm{s}$ )

## ESD Test Conditions

ESD performance depends on a number of conditions. Contact Maxim for a reliability report that documents test setup, methodology, and results.

## Human Body Model

Figure 15a shows the Human Body Model, and Figure 15b shows the current waveform it generates when discharged into a low impedance. This model consists of a 100 pF capacitor charged to the ESD voltage of interest, which is then discharged into the device through a $1.5 \mathrm{k} \Omega$ resistor.

## IEC 1000-4-2

The IEC 1000-4-2 standard covers ESD testing and performance of finished equipment; it does not specifically refer to integrated circuits.
The main difference between tests done using the Human Body Model and IEC 1000-4-2 is higher peak current in IEC 1000-4-2. Because series resistance is lower in the IEC 1000-4-2 ESD test model (Figure 16), the ESD withstand voltage measured to this standard is generally lower than that measured using the Human Body Model. The Air-Gap test involves approaching the device with a charged probe. The Contact Discharge method connects the probe to the device before the probe is energized.

## Machine Model

The Machine Model for ESD testing uses a 200 pF storage capacitor and zero-discharge resistance. It mimics the stress caused by handling during manufacturing and assembly. All pins (not just RS-485 inputs) require this protection during manufacturing. Therefore, the Machine Model is less relevant to the I/O ports than are the Human Body Model and IEC 1000-4-2.

## Applications Information

## 256 Transceivers on the Bus

The standard RS-485 receiver input impedance is $12 \mathrm{k} \Omega$ (one-unit load), and the standard driver can drive up to 32 -unit loads. The MAX3060E family of transceivers have a $1 / 8$-unit-load receiver input impedance ( $96 \mathrm{k} \Omega$ ), allowing up to 256 transceivers to be connected in parallel on one communication line. Any combination of these devices and/or other RS-485 transceivers with a total of 32 unit loads or less can be connected to the line.

## Reduced EMI and Reflections

The MAX3060E and MAX3061E are slew-rate limited, minimizing EMI and reducing reflections caused by improperly terminated cables. Figure 17 shows the driver output waveform and its Fourier analysis of a 25 kHz


Figure 15a. Human Body ESD Test Model


Figure 15b. Human Body Current Waveform


Figure 16. IEC 1000-4-2 ESD Test Model
signal transmitted by a MAX3062E. High-frequency harmonic components with large amplitudes are evident. Figure 18 shows the same signal displayed for a MAX3061E transmitting under the same conditions.

Figure 18 's high-frequency harmonic components are much lower in amplitude, compared with Figure 17's, and the potential for EMI is significantly reduced. Figure 19 shows the same signal displayed for a MAX3060E transmitting under the same conditions. Figure 19's highfrequency harmonic components are even lower.
In general, a transmitter's rise time relates directly to the length of an unterminated stub, which can be driven with only minor waveform reflections. The following equation expresses this relationship conservatively:

$$
\text { Length = tRISE / (10 x } 1.5 \mathrm{~ns} / \mathrm{ft})
$$

where $\mathrm{t}_{\text {RISE }}$ is the transmitter's rise time.
For example, the MAX3060E's rise time is typically 1850 ns , which results in excellent waveforms with a stub length up to 123 ft . A system can work well with longer unterminated stubs, even with severe reflections, if the waveform settles out before the UART samples them.

## Low-Power Shutdown Mode

Low-power shutdown mode is initiated by bringing both $\overline{R E}$ high and DE low. In shutdown, the devices typically draw only 1 nA of supply current.
$\overline{R E}$ and DE can be driven simultaneously. The parts are guaranteed not to enter shutdown if $\overline{R E}$ is high and $D E$ is low for less than 50 ns. If the inputs are in this state for at least 600 ns , the parts are guaranteed to enter shutdown.
Enable timest_zH and t_zl in the Switching Characteristics tables assume the part was not in a lowpower shutdown state. Enable times t ZH(SHDN) and t ZL(SHDN) assume the parts were shut down. It takes drivers and receivers longer to become enabled from low-power shutdown mode ( $\mathrm{t}-\mathrm{ZH}(\mathrm{SHDN}), \mathrm{t}_{\mathrm{ZL}}$ (SHDN) ) than from driver/receiv-er-disable mode ( t _zH, t _ll).

## Driver Output Protection

Two mechanisms prevent excessive output current and power dissipation caused by faults or by bus contention. The first, a foldback current limit on the output stage, provides protection after a $20 \mu \mathrm{~s}$ delay against short circuits over the whole common-mode voltage range (see Typical Operating Characteristics). The second, a thermal shutdown circuit, forces the driver outputs into a high-impedance state if the die temperature becomes excessive.


Figure 17. Driver Output Waveform and FFT Plot of MAX3062E Transmitting a 25 kHz Signal


Figure 18. Driver Output Waveform and FFT Plot of MAX3061E Transmitting a 25 kHz Signal


Figure 19. Driver Output Waveform and FFT Plot of MAX3060E Transmitting a 25 kHz Signal


Figure 20. Typical Half-Duplex RS-485 Network

## Typical Applications

The MAX3060E family of transceivers are designed for bidirectional data communications on multipoint bus transmission lines. Figure 20 shows a typical network application circuit.
To minimize reflections, the line should be terminated at both ends in its characteristic impedance, and stub lengths off the main line should be kept as short as possible. The slew-rate-limited MAX3060E and MAX3061E are more tolerant of imperfect termination.

## Chip Information

PROCESS: CMOS

## Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE <br> TYPE | PACKAGE <br> CODE | OUTLINE <br> NO. | LAND <br> PATTERN |
| :---: | :---: | :---: | :---: |
| SOT 23 | $\mathrm{~K} 8 \mathrm{~F}+4$ | $\underline{21-0078}$ | $\underline{90-0176}$ |

## Revision History

| REVISION <br> NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES <br> CHANGED |
| :---: | :---: | :--- | :---: |
| 2 | $10 / 18$ | Updated Ordering Information | 1 |

